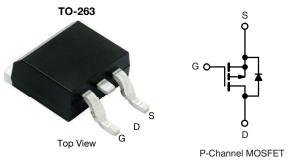


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Automotive P-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	-40			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.00300			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.00380			
I _D (A)	-120			
Configuration	Single			
Package	TO-263			

FEATURES

- TrenchFET® power MOSFET
- · Package with low thermal resistance
- 100 % R_q and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ABSOLUTE MAXIMUM RATINGS	$T_C = 25 ^{\circ}C$, unles	s otherwise noted	l)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	-40	V
Gate-Source Voltage		V_{GS}	± 20	v
Continuous Drain Current a	T _C = 25 °C	1	-120	
Continuous Drain Current "	T _C = 125 °C	l _D	-120	
Continuous Source Current (Diode conduction) ^a Pulsed Drain Current ^b		I _S	-120	Α
		I _{DM}	-300	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	-60	
Single Pulse Avalanche Energy	L = 0.1 IIIIA	E _{AS}	180	mJ
Maximum Power Dissipation ^b	T _C = 25 °C		375	W
Maximum Fower Dissipation 5	T _C = 125 °C	P_{D}	125	VV
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB mount c	R_{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2~\%$.
- c. When mounted on 1" square PCB (FR4 material).

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	: 0 V, I _D = -250 μA	-40	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V_{GS} , $I_{D} = -250 \mu A$	-1.5	-2.0	-2.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = -40 V	-	-	-1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = -40 V, T _J = 125 °C	-	-	-50	μΑ
		$V_{GS} = 0 V$	V _{DS} = -40 V, T _J = 175 °C	-	-	-450	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \le -5 V$	-100	-	-	Α
		V _{GS} = -10 V	I _D = -30 A	-	0.00250	0.00300	
Drain-Source On-State Resistance a	D	V _{GS} = -10 V	I _D = -30 A, T _J = 125 °C	-	-	0.00440	Ω
Dialit-Source Off-State Resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = -30 A, T _J = 175 °C	-	-	0.00520	52
		V _{GS} = -4.5 V	I _D = -25 A	-	0.00316	0.00380	
Forward Transconductance b	9 _{fs}	V _{DS} =	-15 V, I _D = -25 A	-	123	-	S
Dynamic ^b							
Input Capacitance	C _{iss}			-	30 000	39 000	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	-	1850	2500	pF
Reverse Transfer Capacitance	C _{rss}			-	1550	2100	
Total Gate Charge ^c	Qg			-	527	800	
Gate-Source Charge c	Q_{gs}	$V_{GS} = -10 \text{ V}$	$V_{DS} = -20 \text{ V}, I_{D} = -80 \text{ A}$	-	89	-	nC
Gate-Drain Charge ^c	Q_{gd}			-	100	-	
Gate Resistance	Rg		f = 1 MHz	1	2.26	3.5	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	21	35	
Rise Time ^c	t _r		$-20 \text{ V}, \text{ R}_{\text{L}} = 0.3 \Omega$	-	30	50	ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -80 A$,	$V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	250	400	115
Fall Time ^c	t _f			-	165	300	
Source-Drain Diode Ratings and Cha	racteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	-300	Α
Forward Voltage	V _{SD}	I _F =	-80 A, V _{GS} = 0 V	-	-0.85	-1.5	V
Body diode reverse recovery time	t _{rr}			-	70	140	ns
Body diode reverse recovery charge	Q _{rr}	1 - 50	A di/dt = 100 A/ua	-	134	270	nC
Reverse recovery fall time	t _a	I _F = -50	A, di/dt = 100 A/μs	-	43	-	20
Reverse recovery rise time	t _b			-	35	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-4	-8	Α

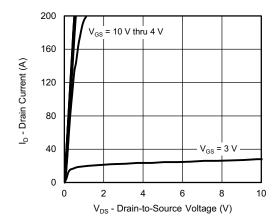
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

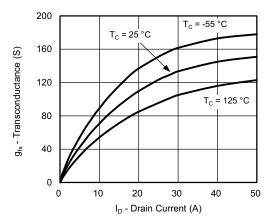
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



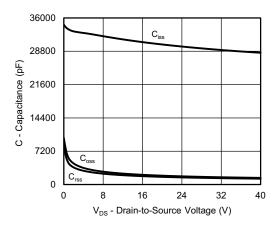
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



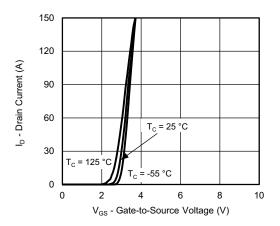
Output Characteristics



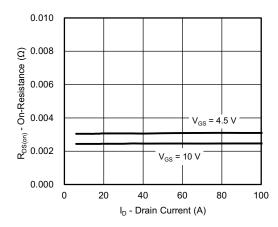
Transconductance



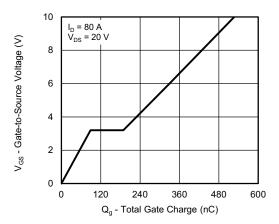
Capacitance



Transfer Characteristics



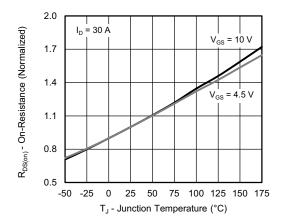
On-Resistance vs. Drain Current



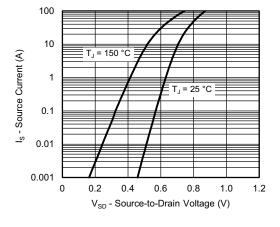
Gate Charge



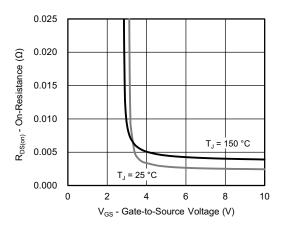
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



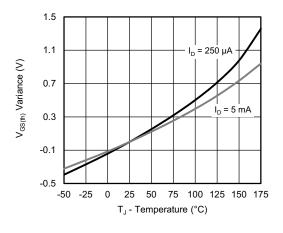
On-Resistance vs. Junction Temperature



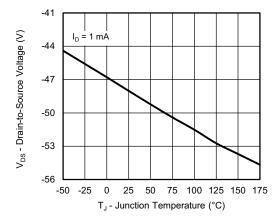
Source Drain Diode Forward Voltage



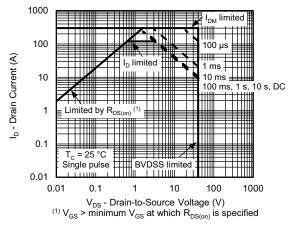
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



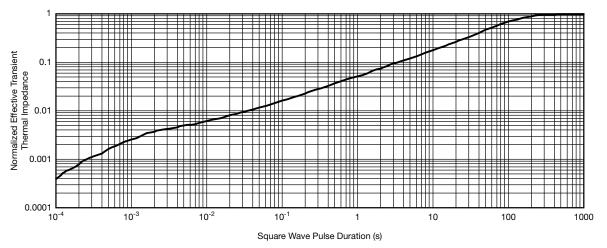
Drain Source Breakdown vs. Junction Temperature



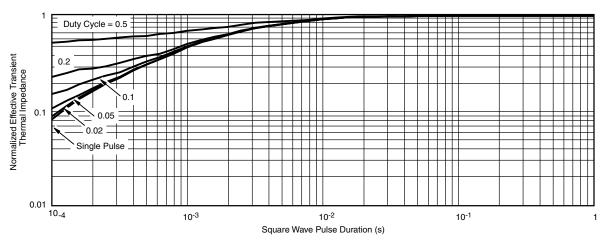
Safe Operating Area



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

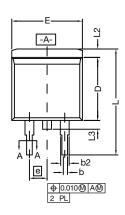
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

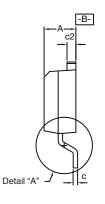
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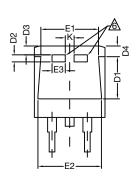
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TO-263 (D²PAK): 3-LEAD

VERSION 1: FACILITY CODE = T

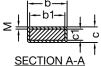








DETAIL A (ROTATED 90°)



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Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

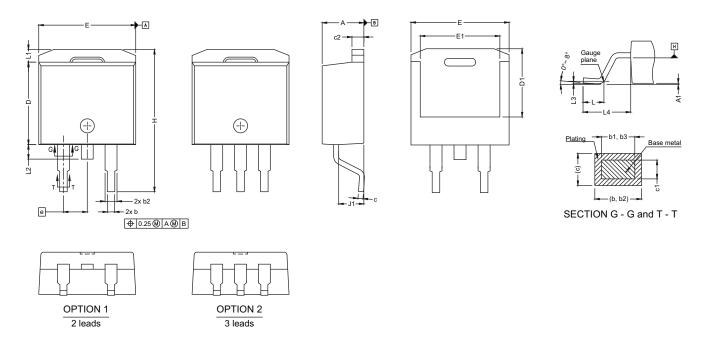
		INCHES		MILLIN	METERS
	DIM.	MIN.	MAX.	MIN.	MAX.
	Α	0.160	0.190	4.064	4.826
b		0.020	0.039	0.508	0.990
	b1	0.020	0.035	0.508	0.889
	b2	0.045	0.055	1.143	1.397
c*	Thin lead	0.013	0.018	0.330	0.457
C	Thick lead	0.023	0.028	0.584	0.711
c1	Thin lead	0.013	0.017	0.330	0.431
Ci	Thick lead	0.023	0.027	0.584	0.685
	c2	0.045	0.055	1.143	1.397
	D	0.340	0.380	8.636	9.652
	D1	0.220	0.240	5.588	6.096
	D2	0.038	0.042	0.965	1.067
	D3	0.045	0.055	1.143	1.397
	D4	0.044	0.052	1.118	1.321
	E	0.380	0.410	9.652	10.414
	E1_	0.245	-	6.223	-
	E2	0.355	0.375	9.017	9.525
	E3	0.072	0.078	1.829	1.981
	е	0.100	BSC	2.54	BSC
K		0.045	0.055	1.143	1.397
	L	0.575	0.625	14.605	15.875
	L1	0.090	0.110	2.286	2.794
	L2	0.040	0.055	1.016	1.397
	L3	0.050	0.070	1.270	1.778
	L4	0.010	BSC	0.254	BSC
	М	-	0.002	-	0.050



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VERSION 2: FACILITY CODE = N



DIM.	MIN.	MAX.
A	4.36	4.56
A1	0	0.25
b	0.70	0.90
b1	0.51	0.89
b2	1.20	1.46
b3	1.17	1.37
С	0.38	0.694
c1	0.38	0.534
c2	1.19	1.34
D	8.60	9.00
D1	6.9	7.5
E	10.15	10.55
E1	8.1	8.7
е	2.54	BSC
Н	15.0	15.6
L	1.9	2.5
L1	-	1.65
L2	-	1.78
L3	0.25 typ.	
L4	4.78 5.28	
J1	2.56 2.96	

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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